

Commission Delegated Directive (EU) 2018/737 of 27 February 2018 amending, for the purposes of adapting to scientific and technical progress, Annex III to Directive 2011/65/EU of the European Parliament and of the Council as regards an exemption for lead in solders for the soldering to machined through hole discoidal and planar array ceramic multilayer capacitors (Text with EEA relevance)

- Article 1 Annex III to Directive 2011/65/EU is amended as set out...
- Article 2 (1) Member States shall adopt and publish, by 30 June 2019...
- Article 3 This Directive shall enter into force on the twentieth day...
- Article 4 This Directive is addressed to the Member States.
- Signature

ANNEX

In Annex III to Directive 2011/65/EU, point 24 is replaced...
24 Lead in solders for the soldering to machined through...

Status: EU Directives are being published on this site to aid cross referencing from UK legislation. After
IP completion day (31 December 2020 11pm) no further amendments will be applied to this version.

- (1) [OJ L 174, 1.7.2011, p. 88.](#)